



## P-Channel Enhancement-Mode Vertical DMOS FETs

### Ordering Information

BV <sub>DSS</sub> / BV <sub>DGS</sub>	R <sub>DS(ON)</sub> (max)	I <sub>D(ON)</sub> (min)	Order Number / Package			
			TO-3	TO-39	TO-220	DICE†
-450V	7.5Ω	-1A	VP0345N1	VP0345N2	VP0345N5	VP0345ND
-500V	7.5Ω	-1A	VP0350N1	VP0350N2	VP0350N5	VP0350ND

† MIL visual screening available

### High Reliability Devices

See pages 5-4 and 5-5 for MILITARY STANDARD Process Flows and Ordering Information.

### Features

- Free from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- Low C<sub>iss</sub> and fast switching speeds
- Excellent thermal stability
- Integral Source-Drain diode
- High input impedance and high gain
- Complementary N- and P-channel devices

### Applications

- Motor control
- Converters
- Amplifiers
- Switches
- Power supply circuits
- Driver (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

### Absolute Maximum Ratings

Drain-to-Source Voltage	BV <sub>DSS</sub>
Drain-to-Gate Voltage	BV <sub>DGS</sub>
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

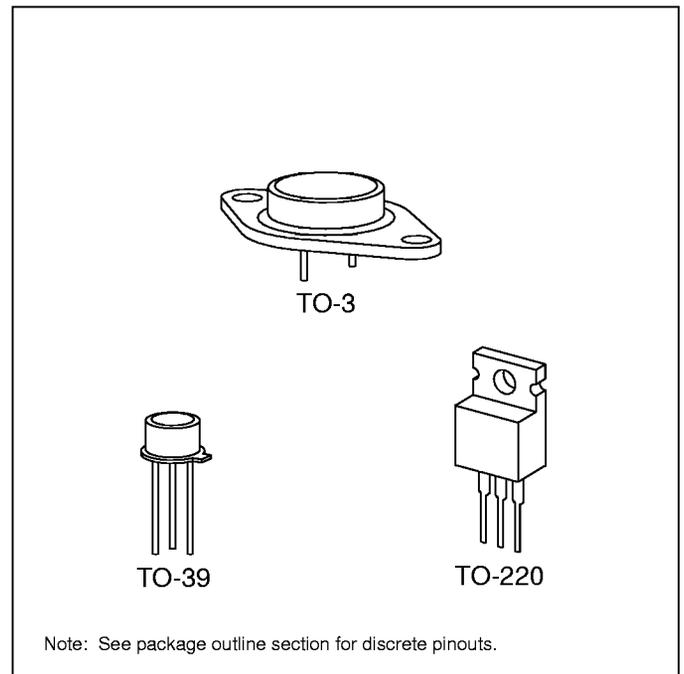
\* Distance of 1.6 mm from case for 10 seconds.

### Advanced DMOS Technology

These enhancement-mode (normally-off) transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

### Package Options



## Thermal Characteristics

Package	$I_D$ (continuous)*	$I_D$ (pulsed)	Power Dissipation @ $T_C = 25^\circ\text{C}$	$\theta_{jc}$ $^\circ\text{C/W}$	$\theta_{ja}$ $^\circ\text{C/W}$	$I_{DR}^*$	$I_{DRM}$
TO-3	-1.5A	-3.0A	100W	1.25	30	-1.5A	-3.0A
TO-39	-0.4A	-3.0A	6W	20.8	125	-0.4A	-3.0A
TO-220	-1.0A	-3.0A	50W	2.5	40	-1.0A	-3.0A

\*  $I_D$  (continuous) is limited by max rated  $T_J$ .

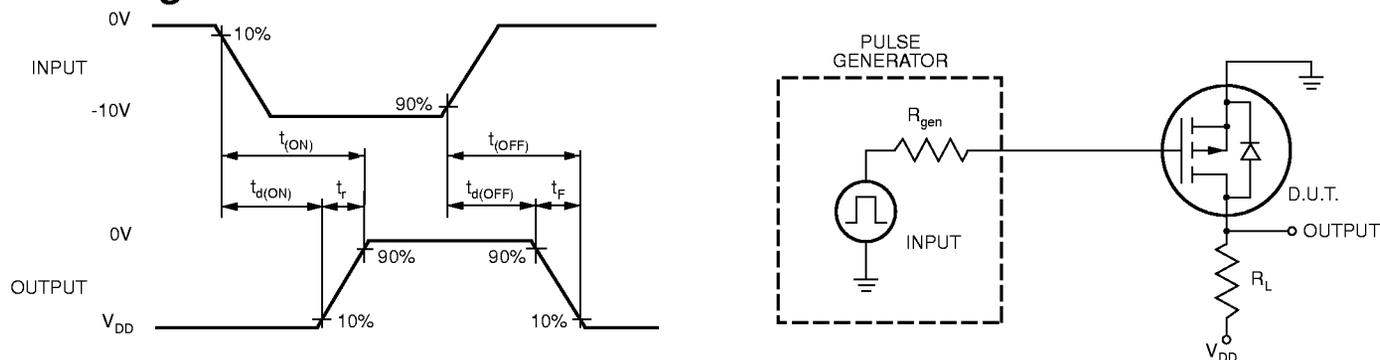
## Electrical Characteristics (@ $25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
$BV_{DSS}$	Drain-to-Source Breakdown Voltage	VP0350	-500			$V_{GS} = 0, I_D = -10\text{mA}$
		VP0345	-450			
$V_{GS(th)}$	Gate Threshold Voltage	-2.5		-4.5	V	$V_{GS} = V_{DS}, I_D = -10\text{mA}$
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with Temperature		4.8	6.0	mV/ $^\circ\text{C}$	$V_{GS} = V_{DS}, I_D = -10\text{mA}$
$I_{GSS}$	Gate Body Leakage			-100	nA	$V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$
$I_{DSS}$	Zero Gate Voltage Drain Current			-200	$\mu\text{A}$	$V_{GS} = 0\text{V}, V_{DS} = \text{Max Rating}$
				-2	mA	$V_{GS} = 0\text{V}, V_{DS} = 0.8 \text{ Max Rating}$ $T_A = 125^\circ\text{C}$
$I_{D(ON)}$	ON-State Drain Current		-1.5		A	$V_{GS} = -5\text{V}, V_{DS} = -25\text{V}$
		-1.0	-3.0	$V_{GS} = -10\text{V}, V_{DS} = -25\text{V}$		
$R_{DS(ON)}$	Static Drain-to-Source ON-State Resistance		6.0		$\Omega$	$V_{GS} = -5\text{V}, I_D = -0.25\text{A}$
			5.5	7.5		$V_{GS} = -10\text{V}, I_D = -0.25\text{A}$
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with Temperature		0.7	1.2	%/ $^\circ\text{C}$	$V_{GS} = -10\text{V}, I_D = -0.25\text{A}$
$G_{FS}$	Forward Transconductance	0.25	0.45		$\text{S}$	$V_{DS} = -25\text{V}, I_D = -0.5\text{A}$
$C_{ISS}$	Input Capacitance		720	800	pF	$V_{GS} = 0\text{V}, V_{DS} = -25\text{V}$ $f = 1 \text{ MHz}$
$C_{OSS}$	Common Source Output Capacitance		110	130		
$C_{RSS}$	Reverse Transfer Capacitance		20	50		
$t_{d(ON)}$	Turn-ON Delay Time		11	30	ns	$V_{DD} = -25\text{V}$ $I_D = -1\text{A}$ $R_{GEN} = 10\Omega$
$t_r$	Rise Time		11	30		
$t_{d(OFF)}$	Turn-OFF Delay Time		70	100		
$t_f$	Fall Time		22	30		
$V_{SD}$	Diode Forward Voltage Drop		-1.0	-1.3	V	$V_{GS} = 0\text{V}, I_{SD} = -0.25\text{A}$
$t_{rr}$	Reverse Recovery Time		550		ns	$V_{GS} = 0\text{V}, I_{SD} = -0.25\text{A}$

### Notes:

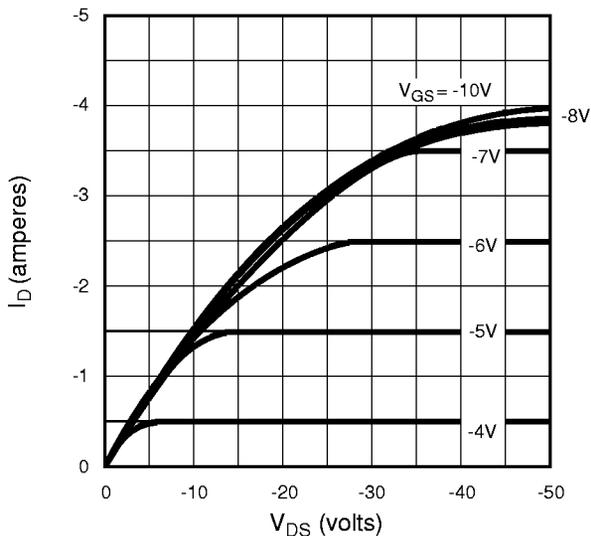
- All D.C. parameters 100% tested at  $25^\circ\text{C}$  unless otherwise stated. (Pulse test: 300 $\mu\text{s}$  pulse, 2% duty cycle.)
- All A.C. parameters sample tested.

## Switching Waveforms and Test Circuit

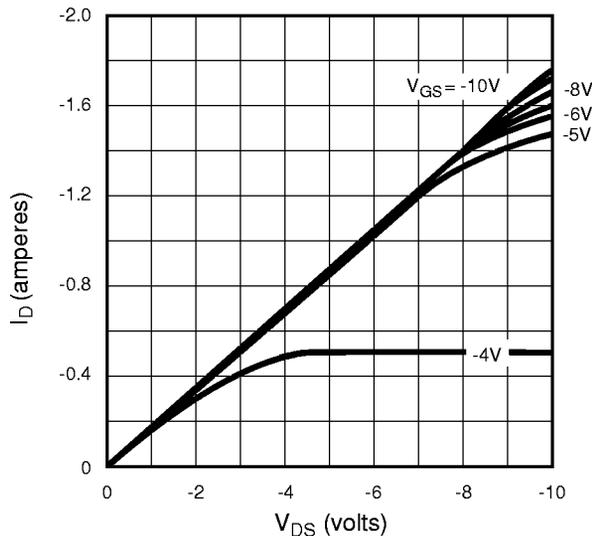


# Typical Performance Curves

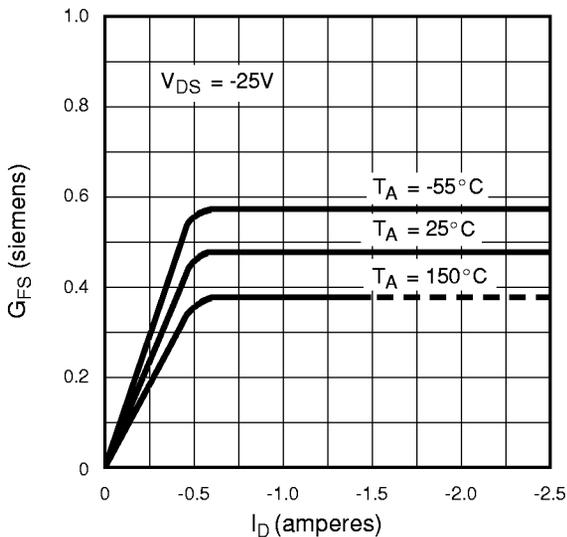
Output Characteristics



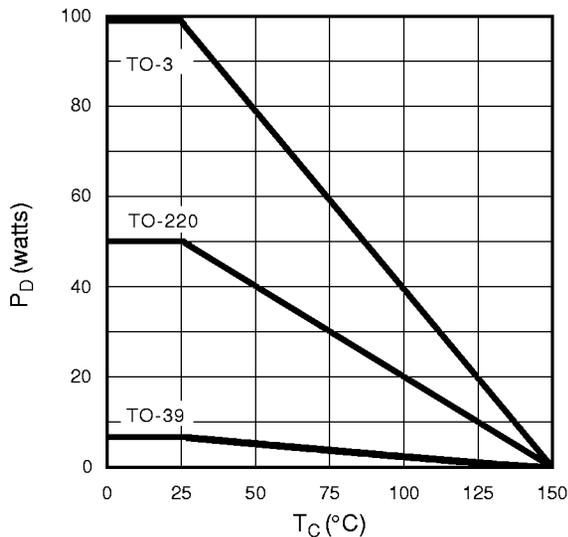
Saturation Characteristics



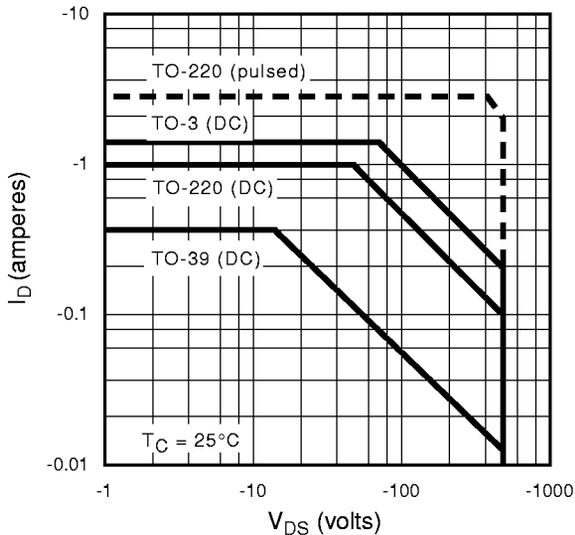
Transconductance vs. Drain Current



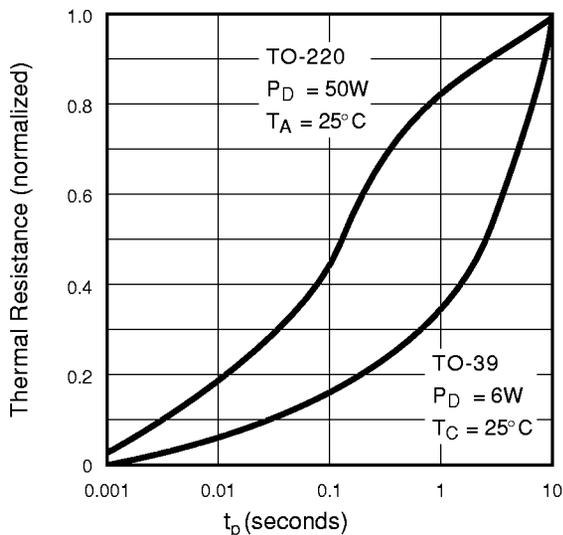
Power Dissipation vs. Case Temperature



Maximum Rated Safe Operating Area



Thermal Response Characteristics



# Typical Performance Curves

